NOTES: UNLESS OTHERWISE SPECIFIED

1. COATINGS ARE 0.5 μM GOLD (99.99% PURE OR BETTER) OVER 0.05 μM CHROMIUM
2. SPUTTERING APPLICATION PREFERRED TO INSURE COATING INSIDE COUNTERSINKS
3. SUBSTRATE TEMPERATURE MAY NOT EXCEED 150 DEG C DURING COATING OR PROCESSING
   - FRONT AND BACK (50 X 47 mm) COATING THICKNESS FACES ± 10% TOL
   - SIDES, BOTTOM AND TOP COATING THICKNESSES MAY BE ±100%/±50%
4. ETCHED UNCOATED PATTERNS ARE 1 mm WIDE
   - WIDTH TOLERANCE ± 0.01 mm EXCEPT INDICATED EDGES
5. INDICATED AREAS MUST BE COATED BUT ELECTRICALLY ISOLATED FROM ALL OTHER AREAS. OTHER AREAS OUTSIDE INDICATED AREAS TO BE ELECTRICALLY CONTIGUOUS
6. DATUM B APPLIES TO INDICATED CROSS-HATCHED AREA ONLY
7. DATUM C APPLIES TO INDICATED CROSS-HATCHED AREA ONLY

REV C - ZONE 6 B, 15.5 WAS 16 MM
CHANGED COATING PATTERN AND TOL ADDED EDGE PROFILE
REV D - REVISED TOLERANCES AND NOTES (13 SEPT 2010)
REV E - REVISED TOLERANCES AND NOTES (18 OCT 2010)
REV F - REMOVED REF LINES, ADDED REF CROSSHAIR (8 MAR 2011)
REV G - REMOVED "GOAL IS ..." FROM GD&T. (12 JUL 2011)